



Detector

Slide

Push

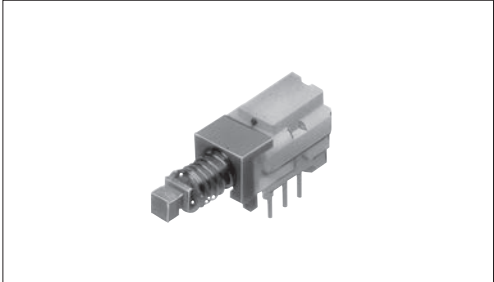
Rotary

Power

Dual-In-Line
Package Type

Horizontal
Type

Vertical
Type



Typical Specifications

Items		Specifications
Rating (max.)/(min.) (Resistive load)		0.1A 30V DC / 50μA 3V DC
Contact resistance (Initial/After operating life)		20mΩ max. / 40mΩ max.
Operating forces	2-pole	1.5±1N
	4-pole	2.3±1N
Operating life	Without load	10,000 cycles
	With load	10,000 cycles (0.1A 30V DC)

Product Line

Changeover timing	Travel (mm)	Total travel (mm)	Mounting method	Poles	Operation	Terminal type	Minimum order unit (pcs.)		Product No.	
							Japan	Export		
Non shorting	2	3	PC board	2	Latching	Straight	100	3,000	SPUJ190900	
						Snap-in			SPUJ191000	
					Momentary	Straight			SPUJ191500	
				Snap-in		SPUJ191900				
				4	Latching	Straight			2,000	SPUJ193700
						Snap-in				SPUJ193900
Momentary	Straight	SPUJ194500								

Note

Please contact us for automotive use.

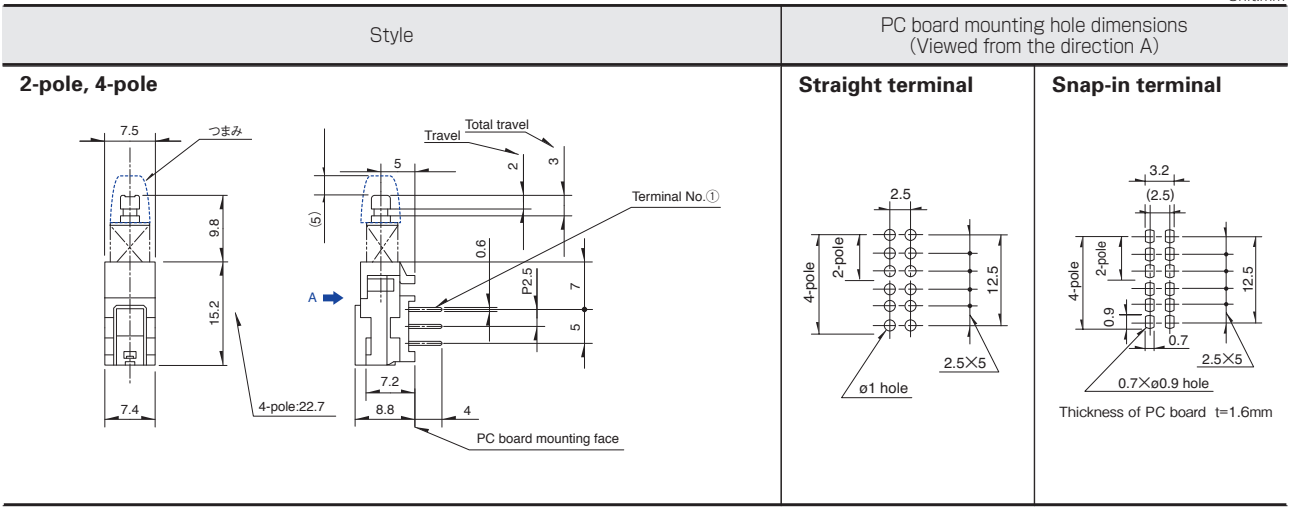
Packing Specifications

Bulk

Product No.	Number of packages (pcs.)		Export package measurements (mm)
	1 case / Japan	1 case / export packing	
SPUJ190900, SPUJ191000, SPUJ191500, SPUJ191900	600	3,000	400×270×290
SPUJ193700, SPUJ193900, SPUJ194500	400	2,000	

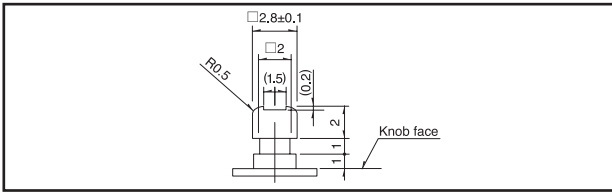
Dimensions

Unit:mm

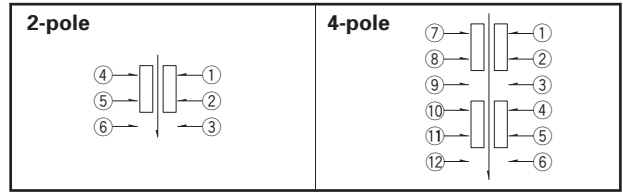


■ Actuator Configuration at Front Edge

Unit:mm



■ Circuit Diagram (Viewed from Direction A)



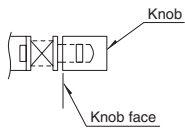
■ Attached Parts

Unit:mm

Knob outline drawing	Model
<p>Color:Black</p>	<p>UJ206022</p>

Notes











1. Other knob varieties are also available. Please inquire.
2. We recommend the use of adhesive to secure the knob when mounting onto switches.



Detector
Slide
Push
Rotary
Power
Dual-In-line Package Type
Horizontal Type
Vertical Type

Push Switches

List of Varieties

Series		Horizontal					
		SPPJ3	SPPJ2	SPUJ※	SPUN	SPUN medium current※	
Photo							
Dimensions (mm)	W	5 or 6.6	7.2	7.5	10		
	D	12		15.2 22.7	24 36		
	H	8.3	9.6	8.8	13		
Travel (mm)		2.5		2	2.5		
Total travel (mm)		3.5		3	3.5		
Number of poles		1 2	2	2 4			
Operating temperature range		-40°C to +85°C		-10°C to +60°C			
Automotive use		●	●	—	—	—	
Life cycle							
Rating (max.) (Resistive load)		0.2A 30V DC		0.1A 30V DC		1A 25V DC	
Rating (min.) (Resistive load)		50μA 3V DC				1A 25V DC	
Durability	Operating life without load	10,000 cycles 40mΩ max.			30,000 cycles 40mΩ max.	10,000 cycles 40mΩ max.	
	Operating life with load (at max. rated load)	10,000 cycles 40mΩ max.				5,000 cycles 40mΩ max.	
Electrical performance	Initial contact resistance	20mΩ max.					
	Insulation resistance	100MΩ min. 500V DC					
	Voltage proof	500V AC for 1minute					
Mechanical performance	Terminal strength	5N for 1minute					
	Actuator strength	Operating direction	50N	30N	50N		
		Pulling direction	—	—	50N		
Environmental performance	Cold	-40°C 96h	-20°C 96h				
	Dry heat	85°C 96h					
	Damp heat	40°C, 90 to 95%RH 96h					
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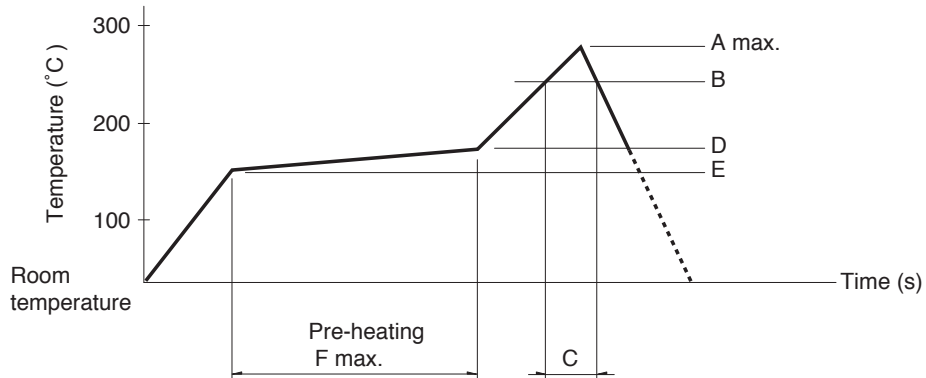
Notes

- ※ The operating temperature range for automotive applications can be raised upon request. Please contact us for details.
- Indicates applicability to all products in the series.

Push Switches Soldering Conditions

Example of Reflow Soldering Condition

1. Heating method: Double heating method with infrared heater.
2. Temperature measurement: Thermocouple ϕ 0.1 to 0.2 CA (K) or CC (T) at soldering portion (copper foil surface). A heat resisting tape should be used for fixed measurement.
3. Temperature profile



Series (Reflow type)	A (°C) 3s max.	B (°C)	C (s)	D (°C)	E (°C)	F (s)
SPEG	260	230	40	180	150	120
SPEJ						
SPEF						
SPEH						

Notes

1. The condition mentioned above is the temperature on the mounting surface of a PC board. There are cases where the PC board's temperature greatly differs from that of the switch, depending on the PC board's material, size, thickness, etc. The above-stated conditions shall also apply to switch surface temperatures.
2. Soldering conditions differ depending on reflow soldering machines. Prior verification of soldering condition is highly recommended.

Reference for Hand Soldering

Series	Soldering temperature	Soldering time
SPPJ3, SPPJ2, SPUN, SPPH4, SPPH1	350±10°C	3+1/0s
SPED2, SPED4	350±10°C	3±0.5s
SPEJ	350±10°C	4s max.
SPEG, SPEF	350±5°C	3s max.
SPEH, SPPH2	350°C max.	3s max.
SPUJ	300±10°C	3+1/0s

Reference for Dip Soldering

(For PC board terminal types)

Series	Items		Dip soldering	
	Preheating temperature	Preheating time	Soldering temperature	Duration of immersion
SPPJ3	100°C max.	60s max.	260±5°C	5±1s
SPUN	100°C max.	60s max.	260±5°C	10±1s
SPUJ, SPPH2, SPPH4	—		260±5°C	5±1s
SPPJ2, SPPH1, SPED2, SPED4, SPEF	—		260±5°C	10±1s